

ITFA'18 Call for Papers

2018 International Workshop on Internet of Thing and FinTech Application

In conjunction with the 7th International Conference on Frontier Computing (FC 2018)

Kuala Lumpur, Malaysia, July 3-6, 2018

Dear Colleagues,

We would like to cordially invite you to submit or recommend papers to ITFA2018 International Workshop on Internet of Thing and Fintech Application (ITFA2018). This conference will be held from July 3-6, 2018 in Kuala Lumpur, Malaysia. The conference will provide a forum for researchers, educators, and professionals to exchange their discoveries, practices and cutting-edge research achievements covering those aspects of the Internet of Thing and Fintech Application. The workshop also explores future trends and applications in these areas and other related areas. Your Participation at the workshop would be an excellent opportunity for you to meet other researchers and to discuss the technology advancements.

Topics of Interest

Areas of interest include, but are not limited to, the following topics:

- Internet of Thing & Internet of Everything
- Intelligent Systems for IoT
- Social Implications of IoT
- Healthcare of IoT
- FinTech Services and Applications
- Network effects of FinTech solutions
- Blockchain Applications

Publication

All accepted papers will be included in the conference proceedings as one of Lecture Notes in Electrical Engineering (LNEE) series published by Springer (indexed by EI and SCOPUS). In addition, FC 2018 features a special publication model for authors to extend their conference works to high quality journals and books after the conference. Submitted papers will be carefully evaluated based on originality, significance, technical soundness, presentation and clarity of exposition. Selected high quality and presented papers, with 30-40% extension and revision, will be recommended to one of the top-rank journals.

Paper Submission

Authors should submit a paper with 10 pages in length including all figures, tables, and references. If you want to submit more than page limitation, you can add up to 2 extra pages with extra charges (USD 125 per page). Instructions for papers in the Springer's LNEE Note that the paper format of LNEE is the same as that of LNCS. Prepare your paper in the exact format as the sample paper for LNEE. Authors should submit their papers in Postscript, PDF, or MS Word format via e-mail to: wwu@mail.hsc.edu.tw.

Important Dates

Paper Submission Deadline: **March 30**, 2018

Acceptance Notification: **April 30**, 2018

Camera Ready Due: **May 15**, 2018

Registration Due: **May 15**, 2018

Conference Dates: **July 3-6**, 2018

Download

Paper Templates:

http://www.springer.com/cda/content/document/cda_downloaddocument/word.zip?SGWID=0-0-45-72919-0

Contacting Information

If you have any question about the CFP and paper submission, please email to Asst. Prof. Wei-Chen Wu wwu@mail.hsc.edu.tw